Lighting ColorYellow Green

LNJ310M6URA

Surface Mounting Chip LED

SV (Side View) -Case Type

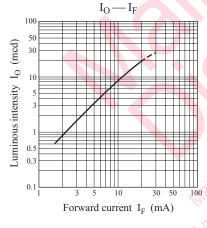
■ Absolute Maximum Ratings $T_a = 25$ °C

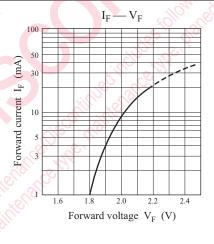
Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	60	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +80	°C	
Storage temperature	T _{stg}	-30 to +85	°C	

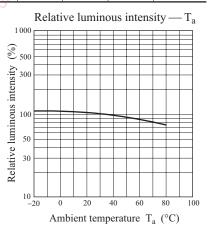
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

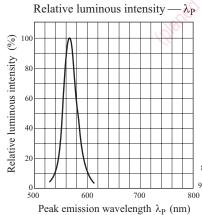
■ Electro-Optical Characteristics $T_a = 25$ °C

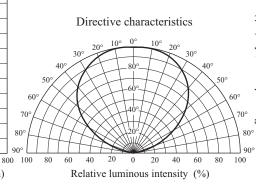
						0 1.11	
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 10 \text{ mA}$		3.0	8.0	5	mcd
Reverse current	I_R	$V_R = 4 V$,,,ct	7160,	10	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$	X	(00, 60	2.03	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$, our	dillo	565		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	91, Q ₁₁	30,	30		nm

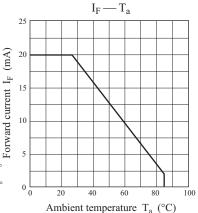












LNJ310M6URA Panasonic

■ Package (Unit: mm)

LLDFSR2J1000



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